



Click [here](#) for the 3D model.

General Information

Series	GoldMax 300 Comm X7R
Style	Radial
Description	GoldMax, Commercial Standard
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov/
SCIP Number	d4c83dcf-0af3-4f6a-8c42-c840cabd6f5b
Termination	Lead (SnPb)
Lead	Formed
Failure Rate	N/A
Halogen Free	Yes

Dimensions

L	5.08mm MAX
H	7.62mm MAX
T	3.18mm MAX
S	5.08mm +/-0.78mm
LL	7mm MIN
F	0.51mm +0.1/-0.025mm

Packaging Specifications

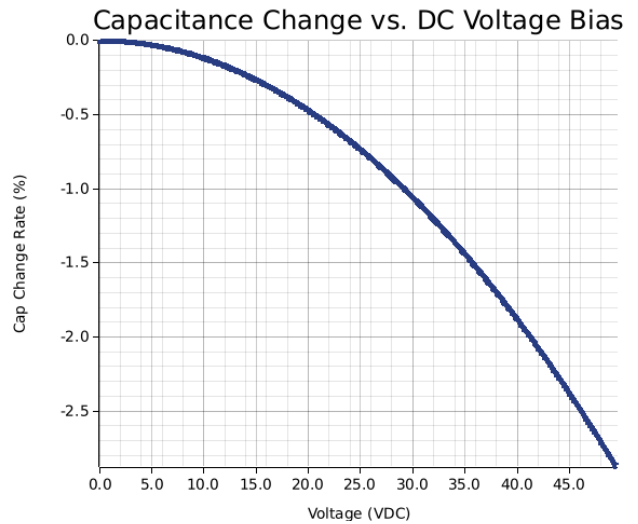
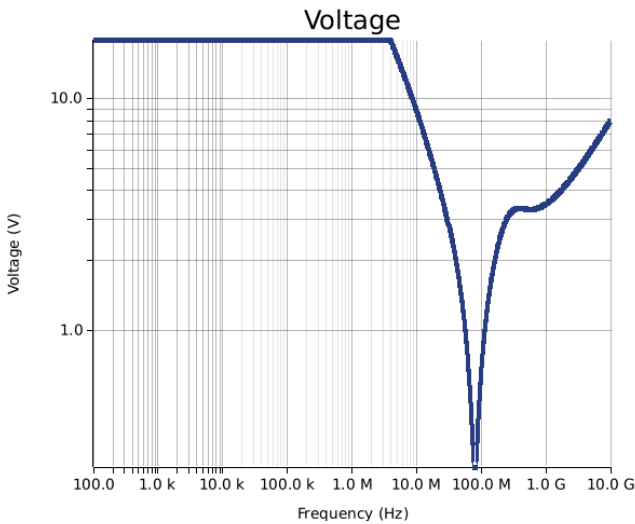
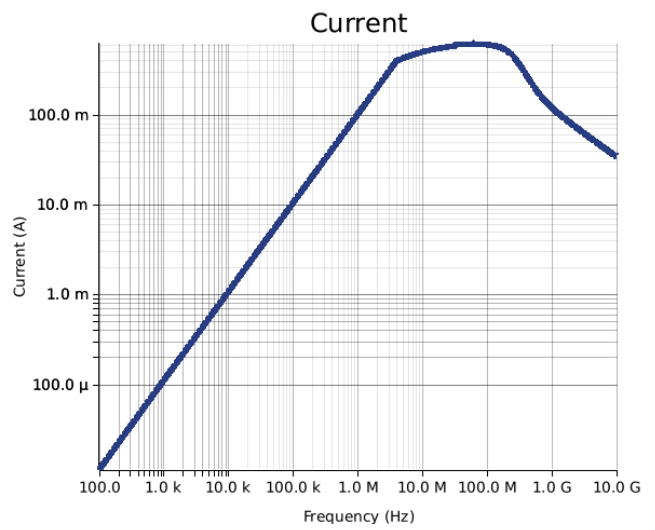
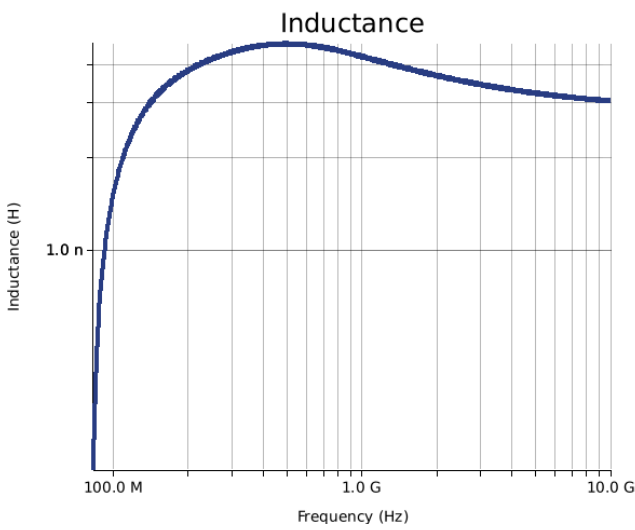
Packaging	Bulk, Bag
Packaging Quantity	500

Specifications

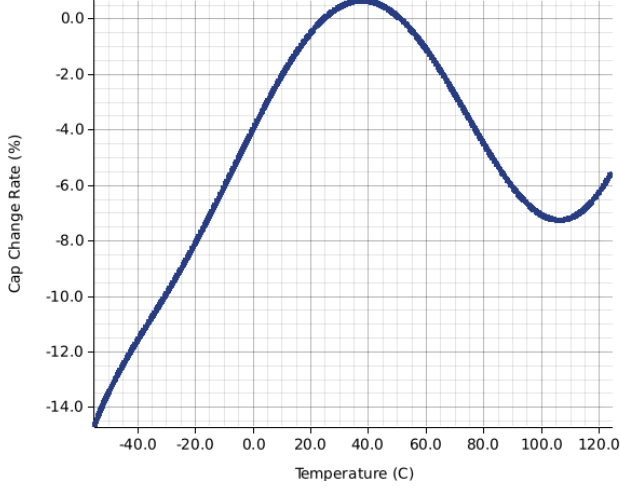
Capacitance	1,000 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	0.15, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour
Insulation Resistance	100 GOhms

Simulations

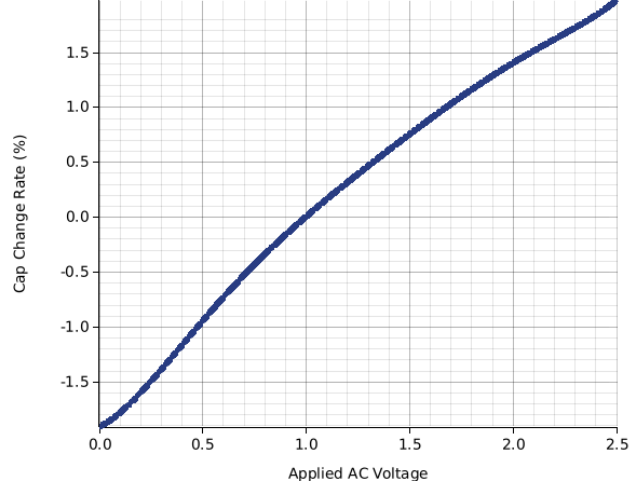
For the complete simulation environment please visit [Y-SIM](#).



Capacitance Change vs. Temperature



Capacitance Change vs. AC Voltage



S11



S21



These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance).
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.